

# Precision, Unity-Gain Differential Amplifier

AMP03

#### **FEATURES**

High CMRR: 100 dB Typ Low Nonlinearity: 0.001% Max Low Distortion: 0.001% Typ Wide Bandwidth: 3 MHz Typ Fast Slew Rate: 9.5 V/μs Typ Fast Settling (0.01%): 1 μs Typ

**Low Cost** 

#### **APPLICATIONS**

Summing Amplifiers
Instrumentation Amplifiers
Balanced Line Receivers
Current-Voltage Conversion
Absolute Value Amplifier
4 to 20 mA Current Transmitter
Precision Voltage Reference Applications
Lower Cost and Higher Speed Version of INA105

#### **GENERAL DESCRIPTION**

The AMP03 is a monolithic unity-gain, high speed differential amplifier. Incorporating a matched thin film resistor network, the AMP03 features stable operation over temperature without requiring expensive external matched components. The AMP03 is a basic analog building block for differential amplifier and instrumentation applications.

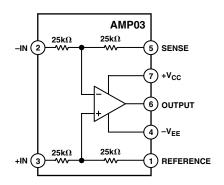
The differential amplifier topology of the AMP03 both amplifies the difference between two signals and provides extremely high rejection of the common-mode input voltage. By providing common-mode rejection (CMR) of 100 dB typical, the AMP03 solves common problems encountered in instrumentation design. As an example, the AMP03 is ideal for performing either addition or subtraction of two signals without using expensive externally matched precision resistors. The large common-mode rejection is made possible by matching the internal resistors to better than 0.002% and maintaining a thermally symmetric layout. Additionally, due to high CMR over frequency, the AMP03 is an ideal general amplifier for buffering signals in a noisy environment into data acquisition systems.

The AMP03 is a higher speed alternative to the INA105. Featuring slew rates of 9.5 V/ $\mu$ s and a bandwidth of 3 MHz, the AMP03 offers superior performance to the INA105 for high speed current sources, absolute value amplifiers, and summing amplifiers.

#### REV. F

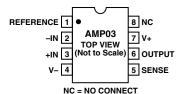
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#### FUNCTIONAL BLOCK DIAGRAM

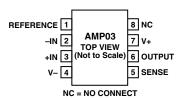


#### PIN CONNECTIONS

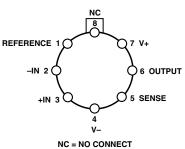
### 8-Lead PDIP (P Suffix)



### 8-Lead SOIC (S Suffix)



## Header (J Suffix)



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## **AMPO3-SPECIFICATIONS**

### **ELECTRICAL CHARACTERISTICS** (@ $V_S = \pm 15 \text{ V}$ , $T_A = +25 ^{\circ}\text{C}$ , unless otherwise noted.)

				AMP03I	7		AMP03B		A	MP030	G	
Parameter	Symbol	Conditions	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Unit
Offset Voltage	Vos	$V_{CM} = 0 \text{ V}$	-400	+10	+400	-700	+20	+700	-750	+25	+750	μV
Gain Error		No Load, $V_{IN} = \pm 10 \text{ V}$ ,										
		$R_S = 0 \Omega$		0.00004	0.008		0.00004	0.008		0.001	0.008	%
Input Voltage Range	IVR	(Note 1)	±20			±20			±20			V
Common-Mode Rejection	CMR	$V_{CM} = \pm 10 \text{ V}$	85	100		80	95		80	95		dB
Power Supply Rejection Ratio	PSRR	$V_S = \pm 6 \text{ V to } \pm 18 \text{ V}$		0.6	10		0.6	10		0.7	10	μV/V
Output Swing	Vo	$R_L = 2 k\Omega$	±12	$\pm 13.7$		±12	$\pm 13.7$		±12	$\pm 13.7$		V
Short-Circuit Current Limit	$I_{SC}$	Output Shorted										
		to Ground	+45/-1	5		+45/-15	5		+45/-15			mA
Small-Signal Bandwidth (-3 dB)	BW	$R_L = 2 k\Omega$		3			3			3		MHz
Slew Rate	SR	$R_L = 2 k\Omega$	6	9.5		6	9.5		6	9.5		V/µs
Capacitive Load Drive												
Capability	$C_{L}$	No Oscillation		300			300			300		pF
Supply Current	$I_{SY}$	No Load		2.5	3.5		2.5	3.5		2.5	3.5	mA

NOTES

Specifications subject to change without notice.

### **ELECTRICAL CHARACTERISTICS** (@ $V_S = \pm 15~V, -55^{\circ}C \le T_A \le +125^{\circ}C$ for B Grade)

				AMP03B		
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Offset Voltage	Vos	$V_{CM} = 0 \text{ V}$	-1500	+150	+1500	μV
Gain Error		No Load, $V_{IN} = \pm 10 \text{ V}$ , $R_S = 0 \Omega$		0.0014	0.02	%
Input Voltage Range	IVR		±20			V
Common-Mode Rejection	CMR	$V_{CM} = \pm 10 \text{ V}$	75	95		dB
Power Supply Rejection						
Ratio	PSRR	$V_{S} = \pm 6 \text{ V to } \pm 18 \text{ V}$		0.7	20	μV/V
Output Swing	$V_{O}$	$R_L = 2 k\Omega$	±12	$\pm 13.7$		V
Slew Rate	SR	$R_L = 2 k\Omega$		9.5		V/µs
Supply Current	$I_{SY}$	No Load		3.0	4.0	mA

Specifications subject to change without notice.

### **ELECTRICAL CHARACTERISTICS** (@ $V_S = \pm 15 V$ , $-40^{\circ}C \le T_A \le +85^{\circ}C$ for F and G Grades)

				AMP03F	·	A	MP03G		
Parameter	Symbol	Conditions	Min	Typ	Max	Min	Typ	Max	Unit
Offset Voltage	Vos	$V_{CM} = 0 \text{ V}$	-1000	+100	+1000	-2000	+200	+2000	μV
Gain Error		No Load, $V_{IN} = \pm 10 \text{ V}$ , $R_S = 0 \Omega$		0.0008	0.015		0.002	0.02	%
Input Voltage Range	IVR		±20			$\pm 20$			V
Common-Mode Rejection	CMR	$V_{CM} = \pm 10 \text{ V}$	80	95		75	90		dB
Power Supply Rejection									
Ratio	PSRR	$V_S = \pm 6 \text{ V to } \pm 18 \text{ V}$		0.7	15		1.0	15	μV/V
Output Swing	Vo	$R_{L} = 2 k\Omega$	±12	$\pm 13.7$		$\pm 12$	$\pm 13.7$		V
Slew Rate	SR	$R_{L} = 2 k\Omega$		9.5			9.5		V/µs
Supply Current	$I_{SY}$	No Load		2.6	4.0		2.6	4.0	mA

Specifications subject to change without notice.

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 $<sup>^{\</sup>mathrm{l}}\mathrm{Input}$  voltage range guaranteed by CMR test.

### WAFER TEST LIMITS (@ $V_S = \pm 15$ V, $T_A = 25^{\circ}$ C, unless otherwise noted.)\*

Parameter	Symbol	Conditions	AMP03GBC Limit	Unit
Offset Voltage	Vos	$V_{S} = \pm 18 \text{ V}$	0.5	mV max
Gain Error		No Load, $V_{IN} = \pm 10 \text{ V}$ , $R_S = 0 \Omega$	0.008	% max
Input Voltage Range	IVR		±10	V min
Common-Mode Rejection	CMR	$V_{CM} = \pm 10 \text{ V}$	80	dB min
Power Supply Rejection Ratio	PSRR	$V_S = \pm 6 \text{ V to } \pm 18 \text{ V}$	8	μV/V max
Output Swing	$V_{O}$	$R_L = 2 k\Omega$	±12	V max
Short-Circuit Current Limit	$I_{SC}$	Output Shorted to Ground	+45/-15	mA min
Supply Current	I <sub>SY</sub>	No Load	3.5	mA max

<sup>\*</sup>Electrical tests are performed at wafer probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.

#### ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

Supply Voltage	±18 V
Input Voltage <sup>2</sup>	Supply Voltage
Output Short-Circuit Duration	Continuous
Storage Temperature Range	
P, J Package	. −65°C to +150°C
Lead Temperature (Soldering, 60 sec)	300°C
Junction Temperature	150°C
Operating Temperature Range	

	_		O	
AM	IP03B			–55°C to +125°C
AM	IP03F	AMP03	G	$-40^{\circ}$ C to $+85^{\circ}$ C

Package Type	$\theta_{JA}^{3}$	$\theta_{ m JC}$	Unit
Header (J)	150	18	°C/W
8-Lead PDIP (P)	103	43	°C/W
8-Lead SOIC (S)	155	40	°C/W

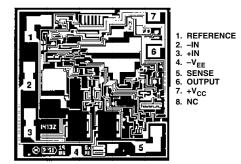
#### NOTES

#### **ORDERING GUIDE**

Model <sup>1</sup>	Temperature Range	Package Description	Package Option <sup>2</sup>
AMP03GP	-40°C to +85°C	8-Lead PDIP	P-8
AMP03BJ	-40°C to +85°C	Header	H-08B
AMP03FJ	-40°C to +85°C	Header	H-08B
AMP03BJ/883C	−55°C to +125°C	Header	H-08B
AMP03GS	-40°C to +85°C	8-Lead SOIC	S-8
AMP03GS-REEL	-40°C to +85°C	8-Lead SOIC	S-8
5962-9563901MGA	−55°C to +125°C	Header	H-08B
AMP03GBC		Die	

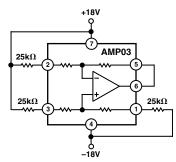
#### NOTES

#### **DICE CHARACTERISTICS**

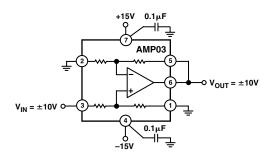


DIE SIZE 0.076 inch  $\times$  0.076 inch, 5,776 sq. mm (1.93 mm  $\times$  1.93 mm, 3.73 sq. mm)

#### **BURN-IN CIRCUIT**



#### **SLEW RATE TEST CIRCUIT**



#### CAUTION -

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AMP03 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



<sup>&</sup>lt;sup>1</sup>Absolute maximum ratings apply to both DICE and packaged parts, unless otherwise noted.

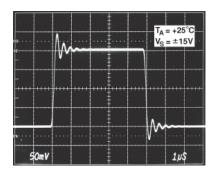
 $<sup>^2</sup> For \ supply \ voltages less than <math display="inline">\pm \, 18 \ V$  , the absolute maximum input voltage is equal to the supply voltage.

 $<sup>^3\</sup>theta_{JA}$  is specified for worst-case mounting conditions, i.e.,  $\theta_{JA}$  is specified for device in socket for header and PDIP packages and for device soldered to printed circuit board for SOIC package.

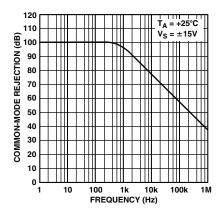
<sup>&</sup>lt;sup>1</sup>Burn-in is available on commercial and industrial temperature range parts in PDIP and header packages.

<sup>&</sup>lt;sup>2</sup>Consult factory for /883 data sheet.

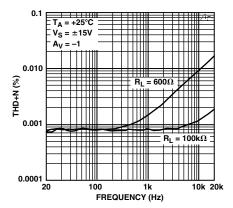
### **AMP03**—Typical Performance Characteristics



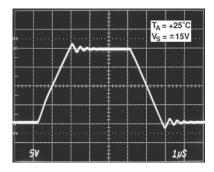
TPC 1. Small Signal Transient Response



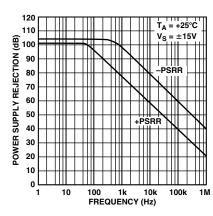
TPC 2. Common-Mode Rejection vs. Frequency



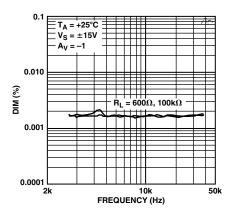
TPC 3. Total Harmonic Distortion vs. Frequency



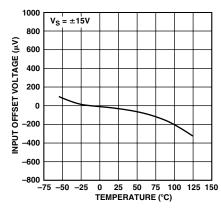
TPC 4. Large Signal Transient Response



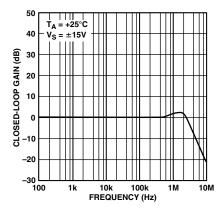
TPC 5. Power Supply Rejection vs. Frequency



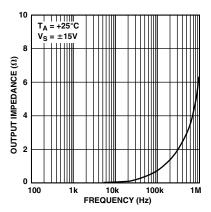
TPC 6. Dynamic Intermodulation Distortion vs. Frequency



TPC 7. Input Offset Voltage vs. Temperature



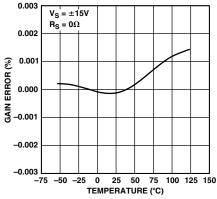
TPC 8. Closed-Loop Gain vs. Frequency



TPC 9. Closed-Loop Output Impedance vs. Frequency

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### AMP03



TPC 10. Gain Error vs. Temperature

T<sub>A</sub> = +25°C

SUPPLY CURRENT (mA)



TPC 13. Supply Current vs. Supply Voltage

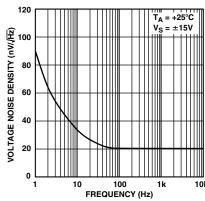
±10

SUPPLY VOLTAGE (V)

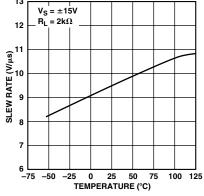
±15

±20

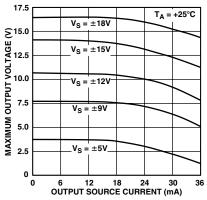
±5



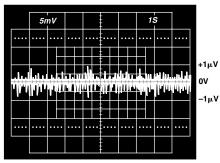
TPC 16. Voltage Noise Density vs. Frequency



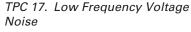
TPC 11. Slew Rate vs. Temperature

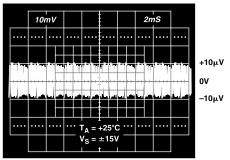


TPC 14. Maximum Output Voltage vs. Output Current (Source)



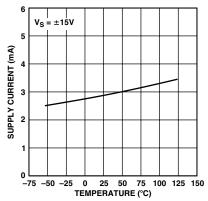
0.1 TO 10Hz PEAK-TO-PEAK NOISE



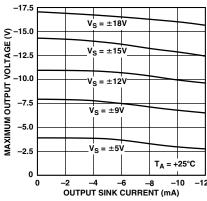


NOTE: EXTERNAL AMPLIFIER GAIN = 1000; THEREFORE, VERTICAL SCALE =  $10\mu V/DIV$ .

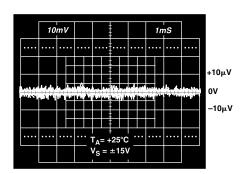
TPC 19. Voltage Noise from 0 kHz to 10 kHz



TPC 12. Supply Current vs. Temperature



TPC 15. Maximum Output Voltage vs. Output Current (Sink)



NOTE: EXTERNAL AMPLIFIER GAIN = 1000; THEREFORE, VERTICAL SCALE =  $10\mu V/DIV$ .

TPC 18. Voltage Noise from 0 kHz to 1 kHz

### AMP03

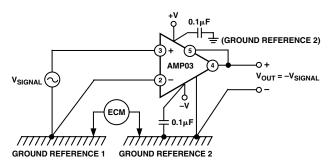


Figure 1. AMP03 Serves to Reject Common-Mode Voltages in Instrumentation Systems. Common-Mode Voltages Occur Due to Ground Current Returns. V<sub>SIGNAL</sub> and  $E_{CM}$  Must Be within the Common-Mode Range of AMP03.

APPLICATIONS INFORMATION

The AMP03 represents a versatile analog building block. In order to capitalize on the fast settling time, high slew rate, and high CMR, proper decoupling and grounding techniques must be employed. Figure 1 illustrates the use of 0.1 µF decoupling capacitors and proper ground connections.

#### MAINTAINING COMMON-MODE REJECTION

In order to achieve the full common-mode rejection capability of the AMP03, the source impedance must be carefully controlled. Slight imbalances of the source resistance will result in a degradation of dc CMR—even a 5  $\Omega$  imbalance will degrade CMR by 20 dB. Also, the matching of the reactive source impedance must be matched in order to preserve the CMRR over frequency.

#### APPLICATION CIRCUITS

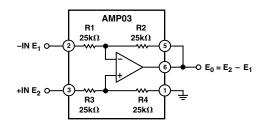


Figure 2. Precision Difference Amplifier. Rejects Common-Mode Signal =  $(E_1 + E_2)/2$  by 100 dB

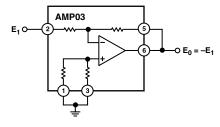


Figure 3. Precision Unity-Gain Inverting Amplifier

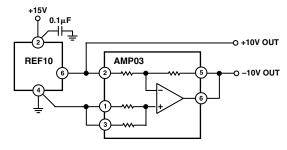


Figure 4. ±10 V Precision Voltage Reference

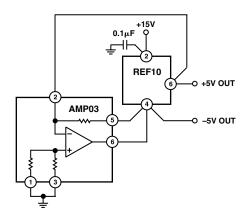


Figure 5. ±5 V Precision Voltage Reference

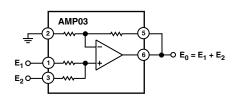


Figure 6. Precision Summing Amplifier

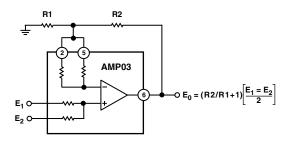


Figure 7. Precision Summing Amplifier with Gain

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### AMP03

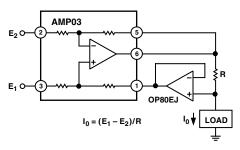


Figure 8. Differential Input Voltage-to-Current Converter for Low  $I_{OUT}$ . OP80EJ maintains 250 fA max input current, allowing  $I_0$  to be less than 1 pA.

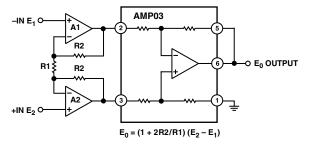


Figure 9. Suitable Instrumentation Amplifier Requirements Can Be Addressed by Using an Input Stage Consisting of A1, A2, R1, and R2. The following matrix suggests a suitable amplifier.

System Design Requirement	Suggested Op Amp For A1 and A2
Source Impedance Low, Need Low Voltage Noise Performance	OP27, OP37 OP227 (Dual Matched) OP270 (Dual) OP271 OP470 OP471
Source Impedance High ( $R_S \ge 15 \text{ k}\Omega$ ). Need Low Current Noise	OP80 OP41 OP43 OP249 OP97
Require Ultrahigh Input Impedance	OP80 OP97 OP41 OP43
Need Wider Bandwidth and High Speed	OP42 OP43 OP249

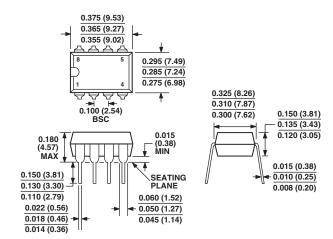
REV. F -7-

#### **OUTLINE DIMENSIONS**

#### 8-Lead Plastic Dual In-Line Package [PDIP] [P Suffix]

(N-8)

Dimensions shown in inches and (millimeters)

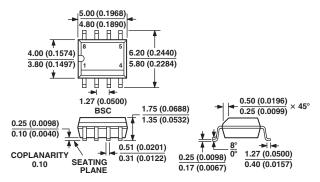


COMPLIANT TO JEDEC STANDARDS MO-095AA
CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

# 8-Lead Small Outline Package [SOIC] [S Suffix]

(R-8)

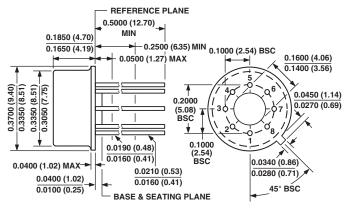
Dimensions shown in millimeters and (inches)



COMPLIANT TO JEDEC STANDARDS MS-012AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

#### 8-Lead Metal Can [TO-99] [J Suffix] (H-08B)

Dimensions shown in inches and (millimeters)



#### COMPLIANT TO JEDEC STANDARDS MO-002AK

CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETERS DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

### **Revision History**

Location	Page
12/03—Data Sheet changed from REV. E to REV. F.	
Changes to ELECTRICAL CHARACTERISTICS	2
Changes to ORDERING GUIDE	3
Updated OUTLINE DIMENSIONS	7

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